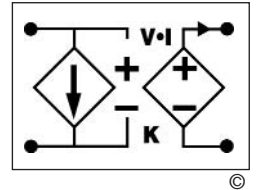


V•I Chip™ – VIC-in-a-Brick

Intermediate Bus Converters Quarter-Brick, 48 Vin Family

1.5 to 48 Vdc Bus Voltages; 100 A - 600 W Output

- Up to 600 W
- 94% Efficiency @ 3 Vdc
- 600 W @ 55°C, 400 LFM
- 125°C operating temperature
- 400 W/in³ power density
- 38-55 Vdc input range
- 100 V input surge for 100 ms
- SAC topology
- Low noise ZCS/ZVS architecture
- 3.5 MHz switching frequency
- Fast dynamic response
- 2,250 Vdc basic insulation
- Parallelable, with fault tolerance



Product Description

These "VIC-in-a-Brick" Intermediate Bus Converter (IBC) modules use Vicor's V•I Chip Bus Converter Modules (BCM) to achieve the highest performance for Intermediate Bus Architecture applications. Operating from a 38 – 55 Vdc input, ten different fixed ratio outputs are available from 3 to 48 Vdc. You can choose the intermediate bus voltage that is optimal for your system and load requirements.

These quarter-bricks are available with a single BCM, rated up to 300 W or 70 A, or with dual BCMs, capable of 600 W or 100 A. Dual output pins are used for output currents over 50 A.

Utilizing breakthrough Sine Amplitude Converter (SAC) technology, BCMs offer the highest efficiency, lowest noise, fastest transient response and highest power density. And full load power is available at 55°C with only 200 LFM of air for single BCM versions and 400 LFM for dual BCM versions, without a heat sink.

Absolute Maximum Ratings

| Parameter | Values | Unit | Notes | |
|---------------------------|-----------------------|------------|------------|----------|
| +In to -In voltage | Continuous | -1.0 to 60 | Vdc | |
| | Surge | 100 | Vdc <100ms | |
| ON/OFF to -In voltage | -0.3 to 7.0 | Vdc | | |
| Isolation voltage | Input to output | 2,250 | Vdc | |
| | In/Out to heat sink | 1,500 | Vdc | |
| | Operating temperature | -40 to 125 | °C | Junction |
| Pin soldering temperature | Wave | 500 (260) | °F (°C) | <5 sec |
| | Hand | 750 (390) | °F (°C) | <7 sec |

Thermal Resistance and Capacity

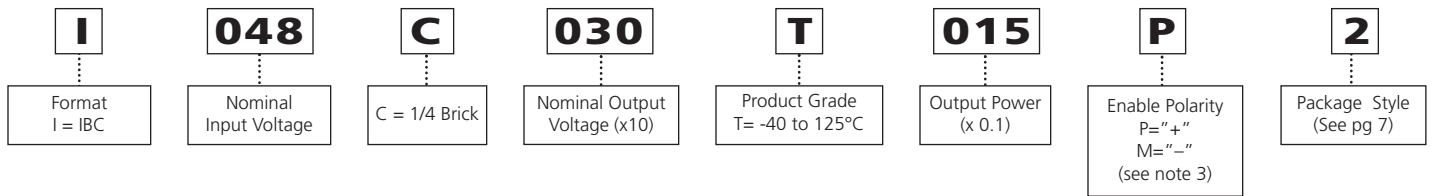
| Parameter | Typ | Unit |
|--------------------------------------|------|-------|
| VIC to ambient; 0 LFM (Single BCM) | 13.3 | °C/W |
| VIC to ambient; 0 LFM (Dual BCM) | 11.7 | °C/W |
| VIC to ambient; 200 LFM (Single BCM) | 6.1 | °C/W |
| VIC to ambient; 200 LFM (Dual BCM) | 4.3 | °C/W |
| Thermal capacity (Single BCM) | 14.3 | Ws/°C |
| Thermal capacity (Dual BCM) | 22.8 | Ws/°C |

PRELIMINARY

General Specifications

V•I Chip Intermediate Bus Converter

Part Numbering



Product Matrix

| Output Voltage (1) | Full Load Output (2) | | Bus Converter Model Number (2) | Number of BCMs | K Factor (Transformation Ratio) | Full Load Efficiency (%) | R _{out} (mΩ) | Max Load Capacitance (4) |
|--------------------|----------------------|--------|--------------------------------|----------------|---------------------------------|--------------------------|-----------------------|--------------------------|
| | Watts | Amps | | | | | | |
| 1.5 | 135 | 90 | I048C015T014P2 | 1 | 1/32 | 92.0 | 1.0 | 100,000 μF |
| 3.0 | 150 | 50 * | I048C030T015P1 | 1 | 1/16 | 94.5 | 2.0 | 31,000 μF |
| | 210 | 70 | I048C030T021P2 | 1 | | 94.1 | 2.0 | 31,000 μF |
| | 300 | 100 ** | I048C030T030P2 | 2 | | 94.3 | 1.0 | 62,000 μF |
| 4.0 | 200 | 50 | I048C040T020P1 | 1 | 1/12 | 93.7 | 3.0 | 17,000 μF |
| | 400 | 100 | I048C040T040P2 | 2 | | 93.5 | 1.5 | 34,000 μF |
| 6.0 | 240 | 40 | I048C060T024P1 | 1 | 1/8 | 94.8 | 7.5 | 7,600 μF |
| | 480 | 80 | I048C060T048P2 | 2 | | | 3.8 | 15,200 μF |
| 8.0 | 240 | 30 | I048C080T024P1 | 1 | | 95.8 | 8.3 | 4,300 μF |
| | 480 | 60 | I048C080T048P2 | 2 | | 95.8 | 4.2 | 8,600 μF |
| 9.6 | 240 | 25 | I048C096T024P1 | 1 | 1/5 | 96.3 | 10.0 | 3,000 μF |
| | 480 | 50 | I048C096T048P1 | 2 | | | 5.1 | 6,000 μF |
| 12 | 300 | 25 | I048C120T030P1 | 1 | 1/4 | 96.0 | 14.0 | 1,000 μF |
| | 600 | 50 | I048C120T060P1 | 2 | | 96.0 | 7.0 | 2,000 μF |
| 16 | 240 | 15.0 | I048C160T024P1 | 1 | 1/3 | 95.7 | 30.0 | 900 μF |
| | 480 | 30.0 | I048C160T048P1 | 2 | | | 15.0 | 1,800 μF |
| 24 | 240 | 10.0 | I048C240T024P1 | 1 | 1/2 | 95.0 | 60.0 | 470 μF |
| | 480 | 20.0 | I048C240T048P1 | 2 | | | 30.0 | 940 μF |
| 32 | 300 | 9.4 | I048C320T030P1 | 1 | 2/3 | 95.0 | 99.0 | 200 μF |
| | 600 | 18.7 | I048C320T060P1 | 2 | | | 48.0 | 400 μF |
| 48 | 300 | 6.3 | I048C480T030P1 | 1 | 1 | 96.3 | 190.0 | 100 μF |
| | 600 | 12.5 | I048C480T060P1 | 2 | | | 95.0 | 200 μF |

* Full load capability is actually 70 A at 3 V. The maximum rating of the output pins is 50 A.

** Full load capability is actually 140 A at 3 V. The maximum rating of the output pins is 100 A.

Notes:

- (1) Output voltage at 48 Vdc input, no load and 25°C temperature.
- (2) Maximum power and current ratings should not be exceeded under normal operating conditions.
- (3) The ending "P" indicates positive enable logic (pull PC pin low to disable). Change to "M" to indicate negative logic (pull PC pin low to enable).
- (4) Exceeding this value can cause the unit not to turn on into load.

PRELIMINARY

Electrical Specifications

V•I Chip Intermediate Bus Converter

For comprehensive data on any of the configurations, please refer to the data sheet for the BCM with output voltage (K Factor) of the Intermediate Bus Converter of interest. Data sheets are available from our website at vicorpower.com.

Electrical characteristics apply over the full operating range of input voltage, output load (resistive) and case temperature, unless otherwise specified.

Input Specifications

| Parameter | Min | Typ | Max | Unit | Notes |
|--|------|------|-----|-------|--|
| Operating input voltage | 38 | 48 | 55 | Vdc | |
| Input surge withstand | | | 100 | Vdc | <100 ms |
| Undervoltage | | | | | |
| Turn-on | | 36.1 | 38 | Vdc | |
| Turn-off | 32.6 | 33.8 | | Vdc | |
| Overvoltage | | | | | |
| Turn-off | 55.0 | | | Vdc | |
| Turn-on | | | 59 | Vdc | |
| Input reflected ripple current | | 3 | | % Iin | mA p-p with recommended external input capacitor |
| Input dV/dt | | | 10 | V/μs | |
| Turn-on time | | | | | |
| Power up | | 300 | | ms | |
| PC enable | | 50 | | μs | |
| No load power dissipation | | 2.5 | | W | per BCM |
| Recommended external input capacitance | 10 | 50 | | μF | 200 nH maximum source inductance |

Output Specifications

| Parameter | Min | Typ | Max | Unit | Notes |
|--------------------------------|-----|-------|-----|--------|--|
| Output voltage accuracy | | ±2 | | % | 48 V input; no load; 25°C |
| Peak repetitive output current | | | 150 | % | <1 ms; see Note 2 below |
| Current limit | | 125 | | % | See Note 1 below |
| Average short circuit current | | 200 | | mA | |
| Efficiency | | 96.0 | | % | 48 Vin; full load; 25°C |
| Output OVP setpoint | | 120 | | % | |
| Line regulation | | | | | Fixed ratio; $V_{out} = V_{in} \cdot K$ (see product matrix) |
| Load regulation | | | | | $\Delta V_{out} = \Delta I_{out} \cdot R_{out}$ (see product matrix) |
| Temperature regulation | | ±0.05 | | % / °C | |
| Ripple and noise, p-p | | 100 | | mV | 48 Vin; full load; 20 MHz bandwidth |
| Switching frequency | | 3.5 | | MHz | Fixed |
| Power sharing accuracy | | ±5 | ±10 | % | 10 to 100% load |
| Transient response | | | | | No load - full load step change, see Note 2 below |
| Voltage deviation | | 2 | | % | |
| Response time | | 200 | | ns | |
| Recovery time | | 1 | | μs | |

Note

- (1) Current limit parameter does not apply for all models. Please see product matrix on Page 2 for exceptions.
- (2) For important information relative to applications where the unit is subjected to continuous dynamic loading, contact Vicor applications engineering at 800-927-9474.

PRELIMINARY

Electrical Specifications (continued)

V•I Chip Intermediate Bus Converter

Safety Specification

| Parameter | Min | Typ | Max | Unit | Notes |
|----------------------------|-------|-------------------|-----|------|---|
| Isolation voltage | | | | | Complies with basic insulation requirements |
| Input to output | 2,250 | | | Vdc | |
| In/Out to chassis | 1,500 | | | Vdc | |
| Isolation resistance | 10 | | | MΩ | Input to output |
| Agency approvals (pending) | | cTÜVus CE Mark | | | UL/CSA 60950, EN 60950 Low voltage directive |

Thermal Specifications

| Parameter | Min | Typ | Max | Unit | Notes |
|--------------------------------|-----|------|-----------|---------|----------------------|
| Operating junction temperature | -40 | | +125 | °C | |
| Storage temperature | -40 | | +150 | °C | |
| Temperature limiting | 125 | 130 | 135 | °C | Junction temperature |
| Thermal capacity | | | | | |
| 1 BCM | | 14.3 | | Ws/°C | |
| 2 BCM | | 22.8 | | Ws/°C | |
| Pin soldering temperature | | | | | |
| Wave | | | 500 (260) | °F (°C) | <5 sec |
| Hand | | | 750 (390) | °F (°C) | <7 sec |

General Specifications

| Parameter | Min | Typ | Max | Unit | Notes |
|------------------------|-----|--------------------|-----|--------|-------------------|
| MTBF | | | | | |
| MIL-HDBK-217F | | 3,600 | | Khrs | 25°C, GB; per BCM |
| Telcordia TR-NY-000332 | | 4,200 | | Khrs | per BCM |
| Weight | | 3.7 (104) | | oz (g) | |
| Dimensions | | 2.3 x 1.45 x 0.47 | | in | L x W x H |
| | | 58,4 x 36,8 x 11,9 | | mm | L x W x H |

Control Specifications – Primary Control (PC Pin)

| Parameter | Min | Typ | Max | Unit | Notes |
|-----------------------------|-----|-----|-----|------|-------------|
| Voltage (P version) | 4.8 | 5.0 | 5.2 | Vdc | |
| Disable voltage (P version) | 2.4 | 2.5 | | Vdc | |
| Enable voltage (P version) | | 2.5 | 2.6 | Vdc | |
| Enable voltage (M version) | 1.2 | 1.5 | | Vdc | |
| Disable voltage (M version) | | 1.5 | 3.5 | Vdc | |
| Current limit (P version) | 2.4 | 2.5 | 2.9 | mA | Source only |

+IN / -IN DC Voltage Input Pins

The "VIC-in-a-Brick" Intermediate Bus Converter (IBC) input voltage range should not be exceeded. The V•I Chip BCM's internal under/over voltage lockout-function prevents operation outside of the normal input range. The BCM turns ON within an input voltage window bounded by the "Input under-voltage turn-on" and "Input over-voltage turn-off" levels, as specified. The IBC may be protected against accidental application of a reverse input voltage by the addition of a rectifier in series with the positive input, or a reverse rectifier in shunt with the positive input located on the load side of the input fuse.

Input Impedance

Vicor recommends a minimum of 10 μ F bypass capacitance be used on-board across the +IN and -IN pins. The type of capacitor used should have a low Q with some inherent ESR such as an electrolytic capacitor. If ceramic capacitance is required for space or MTBF purposes, it should be damped with approximately 0.3 Ω series resistance.

Anomalies in the response of the source will appear at the output of the IBC multiplied by its K factor. The DC resistance of the source should be kept as low as possible to minimize voltage deviations. This is especially important if the IBC is operated near low or high line as the over/under voltage detection circuitry of the BCM(s) could be activated.

ON/OFF – Primary Control

The Primary Control pin is a multifunction node that provides the following functions:

Enable/Disable

Standard "P" configuration — If the PC pin is left floating, the BCM output is enabled. Once this port is pulled lower than 2.4 Vdc with respect to -IN, the output is disabled. This action can be realized by employing a relay, opto-coupler or open collector transistor. This port should not be toggled at a rate higher than 1 Hz.

Optional "M" configuration — This is the reverse function as above: when the PC pin is left floating, the BCM output is disabled.

Primary Auxiliary Supply

The PC pin can source up to 2.4 mA at 5.0 Vdc. (P version only)

Alarm

The BCM contains watchdog circuitry that monitors output overload, input over voltage or under voltage, and internal junction temperatures. In response to an abnormal condition in any of the monitored parameters, the PC pin will toggle. (P version only)

+OUT / -OUT — DC Voltage Output Pins

The 0.062" diameter + and - output pins are rated for a maximum current of 50 A. Two sets of pins are provided for all units with a current rating over 50 A. These pins must be connected in parallel with minimal interconnect resistance. Within the specified operating range, the average output voltage is defined by the Level 1 DC behavioral model of the on board BCM(s) as defined in the appropriate BCM data sheet.

Output Impedance

The very low output impedance of the IBC, as shown in the Product Matrix table, reduces or eliminates the need for limited life aluminum electrolytic or tantalum capacitors at the input of the non-isolated point-of-load converters.

Load Capacitance

Total load capacitance at the output of the IBC should not exceed the specified maximum as shown in the Product Matrix table. Owing to the wide bandwidth and low output impedance of the BCM, low frequency bypass capacitance and significant energy storage may be more densely and efficiently provided by adding capacitance at the input of the IBC.

Bi-directional Operation

The BCM power train and control architecture allow bi-directional power transfer, including reverse power processing from the BCM output to its input. Reverse power transfer is enabled if the BCM input is within its operating range and the BCM is otherwise enabled. The BCM's ability to process power in reverse significantly improves the IBC transient response to an output load dump.

Thermal Management

Figures 2 to 5 provide the IBC's maximum ambient operating temperature vs. BCM power dissipation for a variety of airflows. In order to determine the maximum ambient environment for a given application, the following procedure should be used:

1. Determine the maximum load powered by the IBC.
2. Determine the power dissipated at this load by the on-board BCM(s).
 - a) If using a 1 BCM configuration, this dissipation is found in Fig. 6 on the appropriate BCM data sheet corresponding to the output voltage of the IBC.
 - b) If using a 2 BCM configuration, divide the maximum load by two. The power dissipated by each BCM is found in Fig. 6 on the appropriate BCM data sheet corresponding to the output voltage of the IBC. This number should then be multiplied by two to reflect the total dissipation.

3. Determine the airflow orientation from Fig. 1.
4. Using the chart corresponding to the appropriate airflow angle, find the curve corresponding to the airflow velocity and read the maximum ambient operating temperature of the IBC (y-axis) based on the total BCM power dissipation (x-axis).

For additional information on V•I Chip thermal design, please read the "Thermal Management" section of the BCM data sheet.

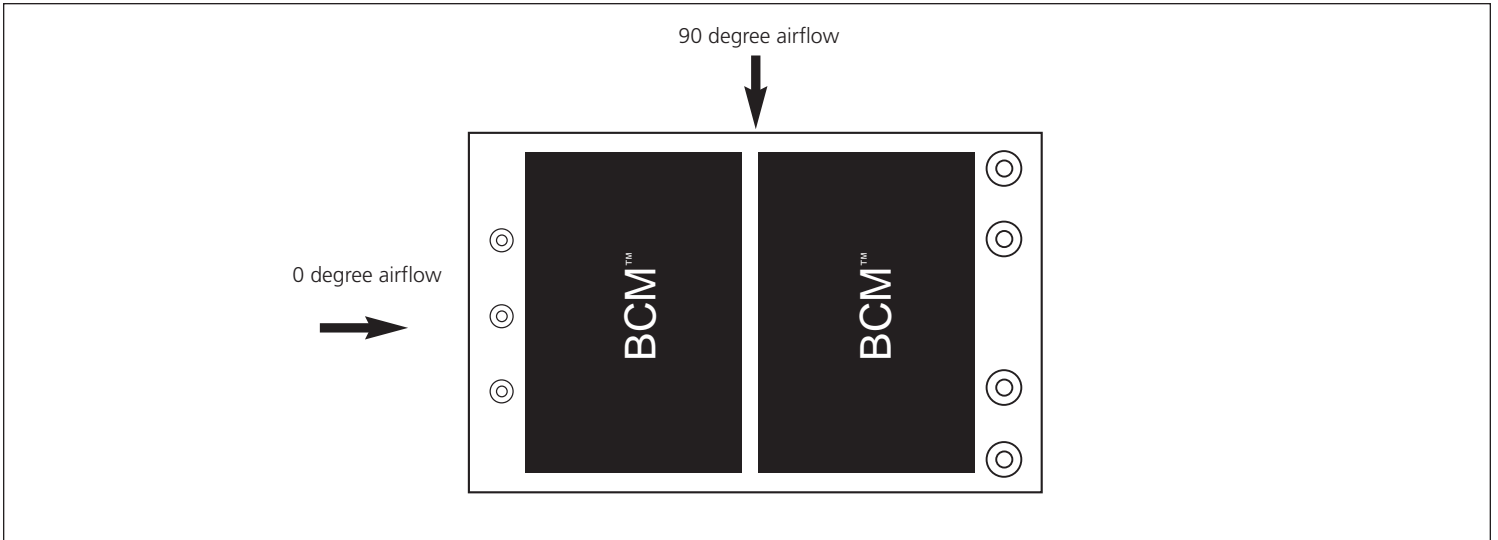


Figure 1— 0 and 90 degree airflow orientations for one or two BCM configurations

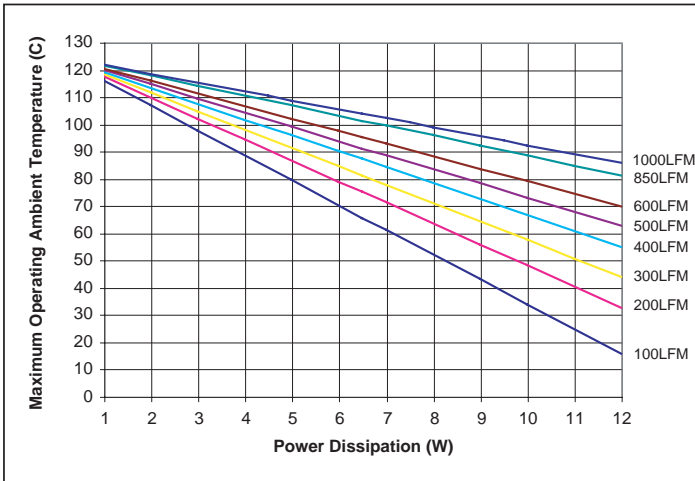


Figure 2— Maximum operating ambient temp. curves for 1 BCM with 0 degree airflow

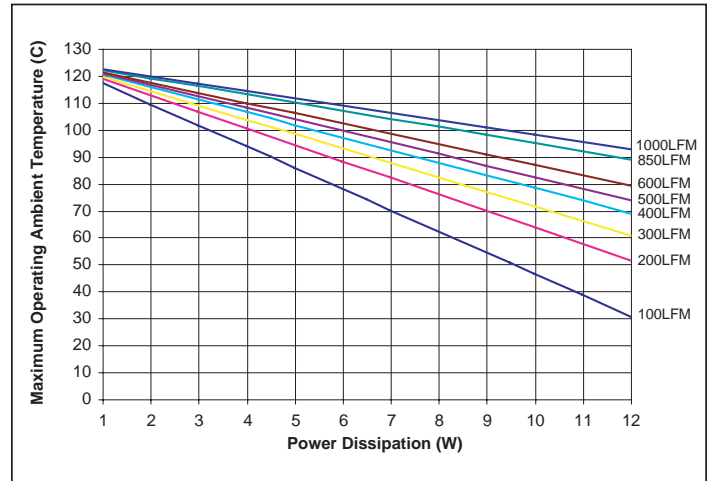


Figure 3— Maximum operating ambient temp. curves for 1 BCM with 90 degree airflow

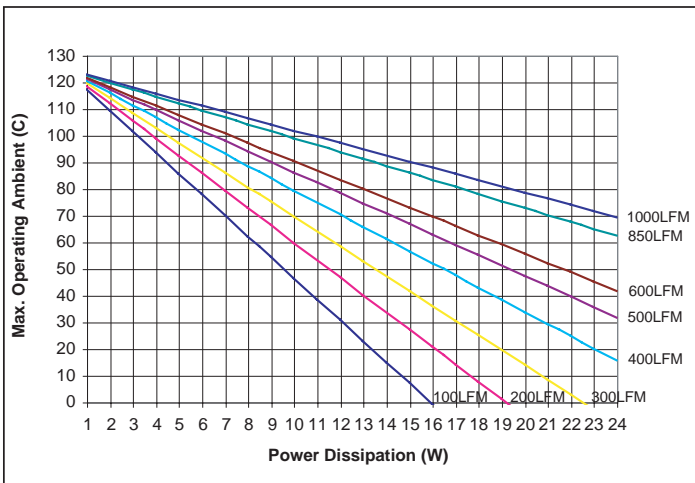


Figure 4— Maximum operating ambient temp. curves for 2 BCM with 0 degree airflow

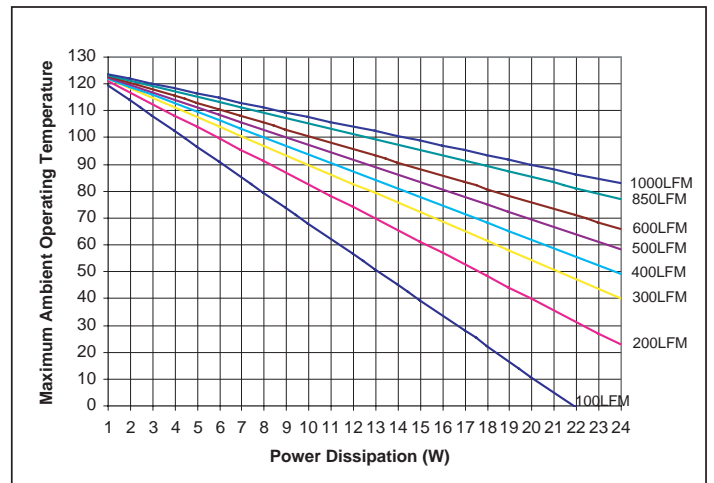
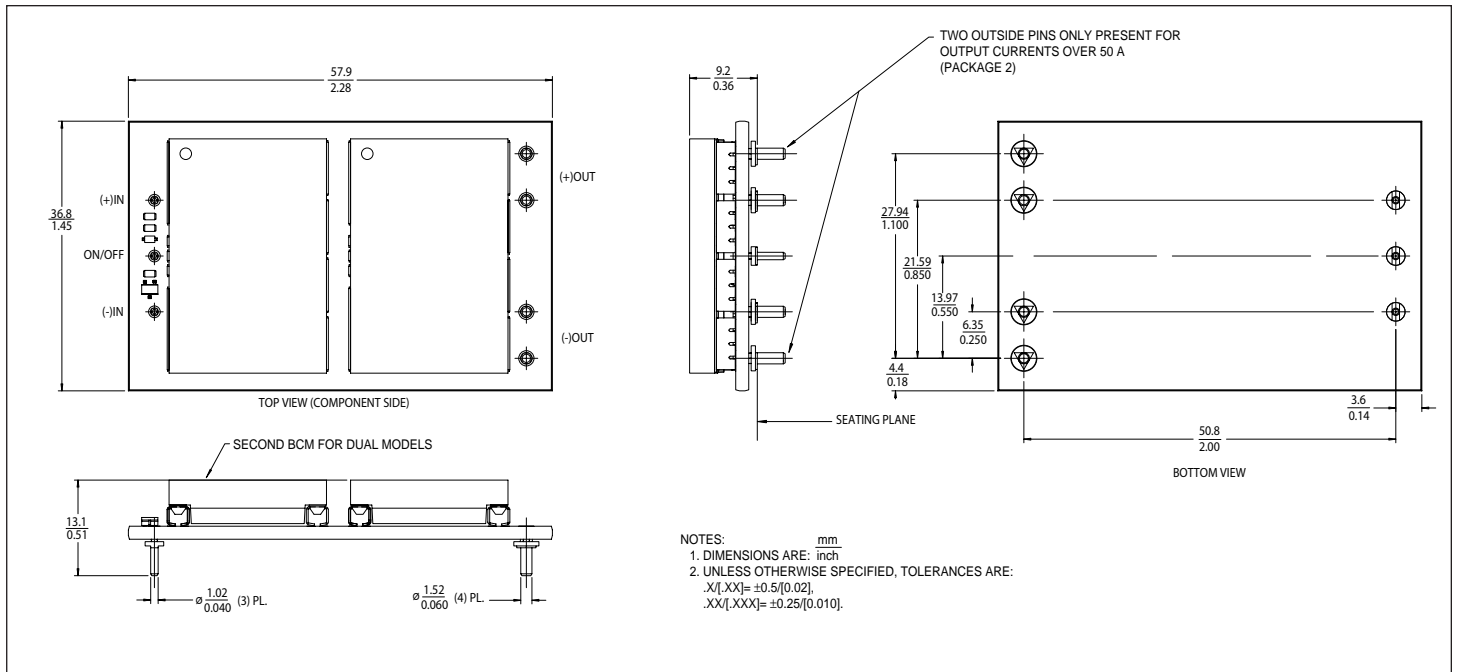


Figure 5— Maximum operating ambient temp. curves for 2 BCM with 90 degree airflow



Package Configurations

| Package Style | Description |
|---------------|--------------------|
| 1 | Single output pins |
| 2 | Dual output pins |

Input Fuse Value

| Bus Converter Model No. | Little Fuse Nano 451/453 Series | San-O SV 12/14 5/20 Series | Little Fuse 3AB Series |
|-------------------------|---------------------------------|----------------------------|------------------------|
| I048C015T014P1 | 6.3 A | | |
| I048C030T015P1 | 6.3 A | | |
| I048C030T021P2 | 8 A | | |
| I048C030T030P2 | 12 A | | |
| I048C040T020P1 | 8 A | | |
| I048C040T040P2 | 15 A | | |
| I048C060T024P1 | 12 A | | |
| I048C060T048P2 | | | 25 A |
| I048C080T024P1 | 12 A | | |
| I048C080T048P2 | | | 25 A |
| I048C096T024P1 | 10 A | | |
| I048C096T048P1 | | | 20A |
| I048C120T030P1 | 12 A | | |
| I048C120T060P1 | | | 25 A |
| I048C160T024P1 | 12 A | | |
| I048C160T048P1 | | | 25 A |
| I048C240T024P1 | 12 A | | |
| I048C240T048P1 | 25 A | | |
| I048C480T030P1 | 12 A | | |
| I048C480T060P1 | | | 25 A |

Input Fusing

V•I Chips are not internally fused in order to provide flexibility in power system configuration. However, input line fusing of V•I Chips must always be incorporated within the power system. The input line fuse should be placed in series with +IN.

Warranty

Vicor products are guaranteed for two years from date of shipment against defects in material or workmanship when in normal use and service. This warranty does not extend to products subjected to misuse, accident, or improper application or maintenance. Vicor shall not be liable for collateral or consequential damage. This warranty is extended to the original purchaser only.

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